

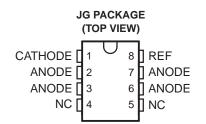
FEATURES

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- 0.4% Initial Voltage Tolerance
- 0.2-Ω Typical Output Impedance
- Fast Turnon . . . 500 ns
- Sink Current Capability ... 1 mA to 100 mA
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DESCRIPTION/ORDERING INFORMATION

Low Reference Current (REF)

Adjustable Output Voltage . . . V_{I(ref)} to 36 V



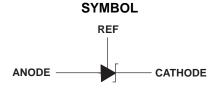
NC – No internal connection ANODE terminals are connected internally.

The TL1431 is a precision programmable reference with specified thermal stability over the automotive temperature range. The output voltage can be set to any value between $V_{l(ref)}$ (approximately 2.5 V) and 36 V with two external resistors (see Figure 16). This device has a typical output impedance of 0.2 Ω . Active output circuitry provides a very sharp turnon characteristic, making the device an excellent replacement for Zener diodes and other types of references in applications such as onboard regulation, adjustable power supplies, and switching power supplies.

ORDERING INFORMATION

	T _A	PACK	AGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-40°C to 12	25°C	SOIC – D	Reel of 2500	TL1431QDREP	1431QE	
–55°C to 12	25°C	SOIC – D	Reel of 2500	TL1431MDREP	1431ME	

(1) Package drawings, standard packing quantities, thermal data, symbolizatin, and PCB design guidelines are available at www.ti.com/sc/package.

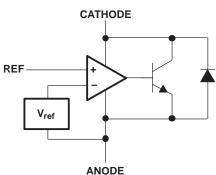




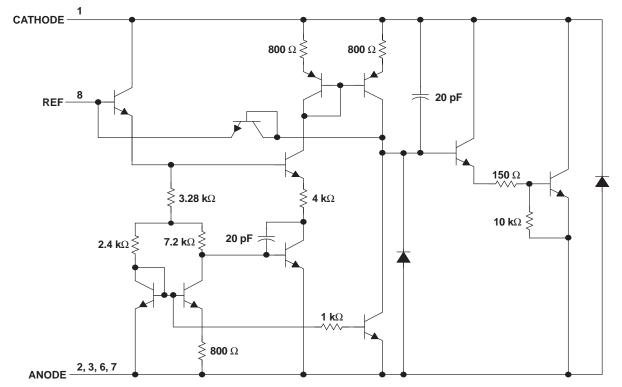
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FUNCTIONAL BLOCK DIAGRAM



EQUIVALENT SCHEMATIC⁽¹⁾



(1) All component values are nominal.

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{KA}	Cathode voltage ⁽²⁾		37	V
I _{KA}	Continuous cathode current range	-100	150	mA
I _{I(ref)}	Reference input current range	–50 μA	10 mA	
θ _{JA} (High)	Package thermal impedance (High K Board) ⁽³⁾⁽⁴⁾		97	°C/W
$\theta_{JA (Low)}$	Package thermal impedance (Low K Board) ⁽³⁾⁽⁴⁾		165	°C/W
TJ	Operating virtual junction temperature ⁽⁵⁾		150	°C
	Continuous total power dissipation		ssipation ing Table	
	Lead temperature 1,6 mm(1/16 in) from case for 10 s		260	°C
T _{stg}	Storage temperature range ⁽⁵⁾	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2)

All voltage values are with respect to ANODE, unless otherwise noted. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded. (3)

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

Long-term high-temperature storage and/or use at the absolute maximum ratings may result in a reduction of overall device life. See (5) http://www.ti.com/ep_quality for additional information on enhanced plastic packaging.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25^{\circ}C$ POWER RATING	PACKAGE THERMAL IMPEDANCE	DERATING FACTOR ABOVE $T_A = 25^{\circ}C$	T _A = 70°C ABSOLUTE MAXIMUM POWER RATING	T _A = 85°C ABSOLUTE MAXIMUM POWER RATING	T _A = 125°C ABSOLUTE MAXIMUM POWER RATING
D	1102 mW	97°C/W (High K Board)	10 mW/°C	824 mW	670 mW	257 mW
U		165°C/W (Low K Board)	6 mW/°C	484 mW	393 mW	151 mW

Recommended Operating Conditions

		MIN	MAX	UNIT
V _{KA}	Cathode voltge	V _{I(ref)}	36	V
I _{KA}	Cathode current	1	100	mA
T _A	Operating free-air temperature	-55	125	°C

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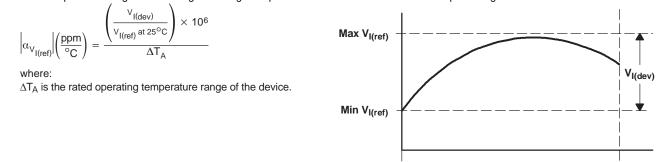
Electrical Characteristics

at specified free-air temperature, I_{KA} = 10 mA (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A (1)	TEST CIRCUIT	MIN	ТҮР	МАХ	UNIT
V	Deference innut veltere	$V_{KA} = V_{I(ref)}$		25°C	_	2490	2500	2510	
V _{I(ref)}	Reference input voltage			Full range Figure 1		2470		2530	mV
V _{I(dev)}	Deviation of reference input voltage over full temperature range ⁽²⁾	$V_{KA} = V_{I(ref)}$		Full range	Figure 1		17		mV
$\frac{\Delta V_{\text{I(ref)}}}{\Delta V_{\text{KA}}}$	Ratio of change in reference input voltage to the change in cathode voltage	$\Delta V_{KA} = 3 V \text{ to } 3$	36 V	Full range	Figure 2		-1.1	-2	mV/V
	Poforonoo input ourront	R1 = 10 kΩ.	R2 = ∞	25°C	Figure 2		1.5	2.5	۸
I _{I(ref)}	Reference input current	$R_1 = 10 K_{22}$	K2 = ∞	Full range	Figure 2			4	μA
I _{I(dev)}	Deviation of reference input current over full temperature range ⁽²⁾	R1 = 10 kΩ,	R2 = ∞	Full range	Figure 2		0.5		μA
I _{min}	Minimum cathode current for regulation	$V_{KA} = V_{I(ref)}$		25°C	Figure 1		0.45	1	mA
	Off-state cathode current	$V_{KA} = 36 \text{ V}, \qquad V_{I(ref)} = 0$		25°C	Figure 0		0.18	0.5	μA
l _{off}	On-state cathode current			Full range	Figure 3			2	
z _{KA}	Output impedance ⁽³⁾	$V_{KA} = V_{I(ref)}, f \le I_{KA} = 1 \text{ mA to } 1$		25°C	Figure 1		0.2	0.4	Ω

(1) Full range is -40°C to 125°C for Q-suffix devices; -55°C to 125°C for M-suffix devices.

(2) The deviation parameters $V_{I(dev)}$ and $I_{I(dev)}$ are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage $\alpha_{VI(ref)}$ is defined as:



 $\alpha_{V_{l(ref)}}$ is positive or negative, depending on whether minimum $V_{l(ref)}$ or maximum $V_{l(ref)}$, respectively, occurs at the lower temperature.

 ΔT_A

(3) The output impedance is defined as:
$$|z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{KA}}$$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is given by:
 $|z'| = \frac{\Delta V}{\Delta I}$, which is approximately equal to $|z_{KA}| = \left(1 + \frac{R1}{R2}\right)$.

PARAMETER MEASUREMENT INFORMATION

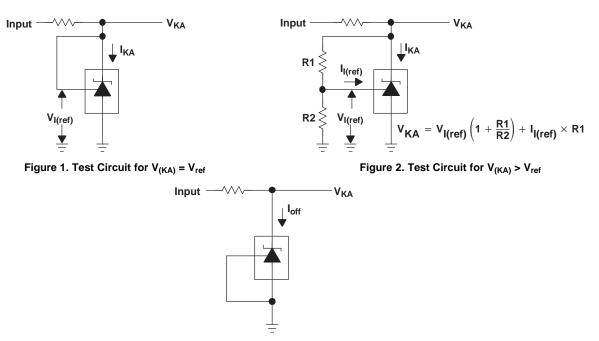


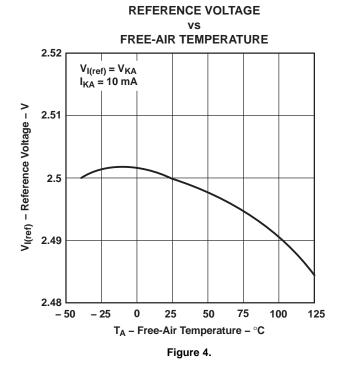
Figure 3. Test Circuit for Ioff

TYPICAL CHARACTERISTICS(1)

(1) Data at high and low temperatures are applicable only within the recommended operating free-air temperature ranges of the various devices.

	FIGURE
Reference voltage vs Free-air temperature	4
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REFERENCE CURRENT vs FREE-AIR TEMPERATURE

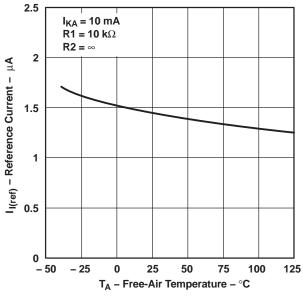


Figure 5.

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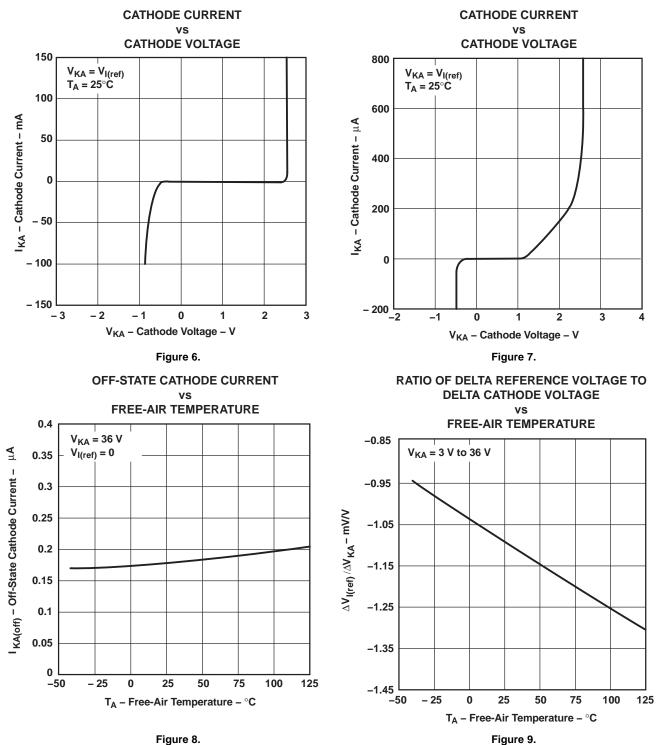
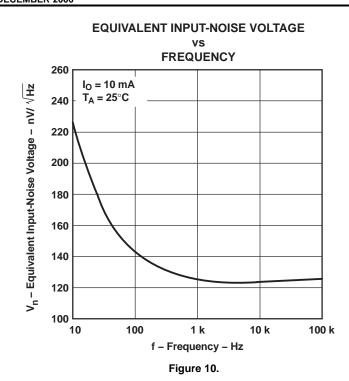
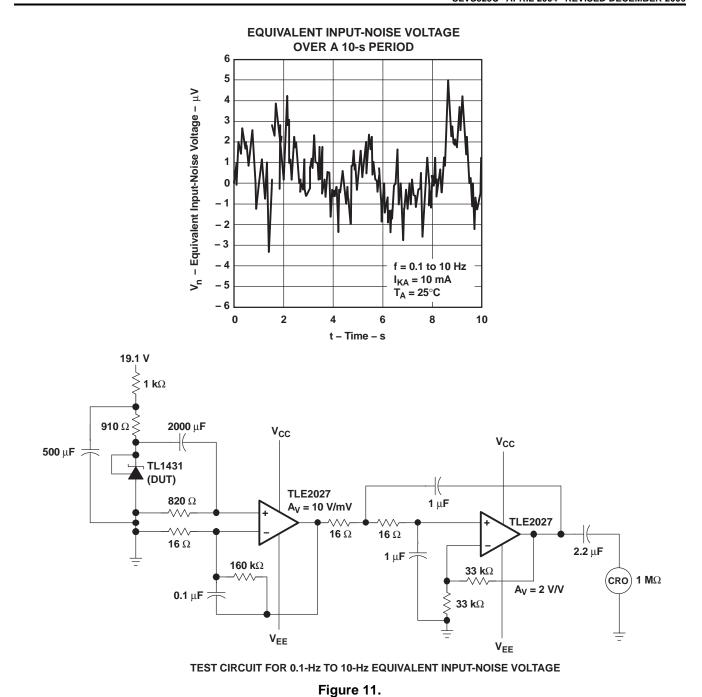


Figure 8.

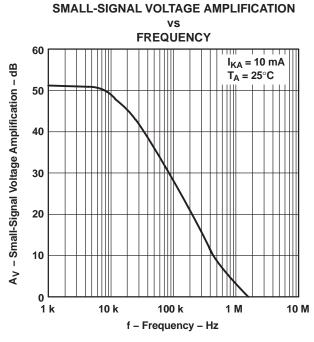


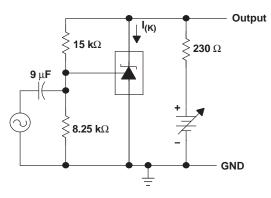




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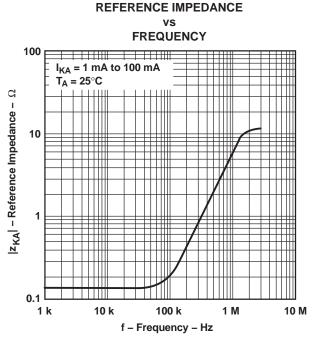
TEXAS INSTRUMENTS www.ti.com

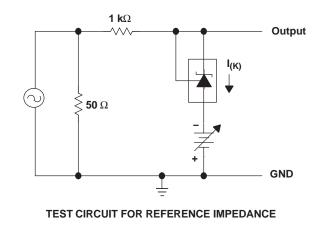




TEST CIRCUIT FOR VOLTAGE AMPLIFICATION









6 T_A = 25°C V Input 5 Input and Output Voltages – V 4 Pulse ≶ Generator 3 f = 100 kHz Output 2 1 0 0 1 2 3 4 5 6 7 t – Time – μ s

PULSE RESPONSE

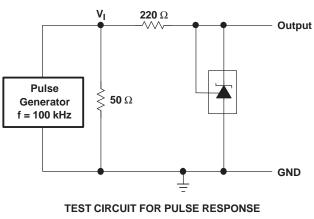
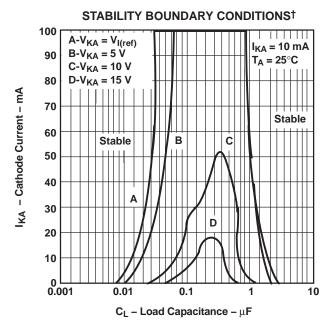
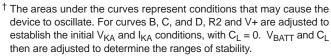
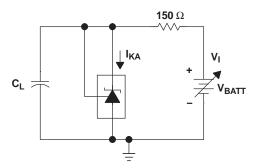


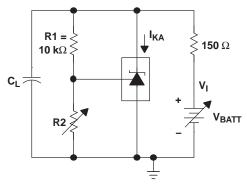
Figure 14.







TEST CIRCUIT FOR CURVE A



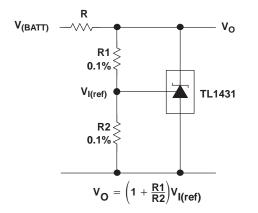
TEST CIRCUIT FOR CURVES B, C, AND D



APPLICATION INFORMATION

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Crowbar	21
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Voltage monitor	25
Delay timer	26
Precision current limiter	27
Precision constant-current sink	28



NOTE A: R should provide cathode current \geq 1 mA to the TL1431 at minimum V_(BATT).



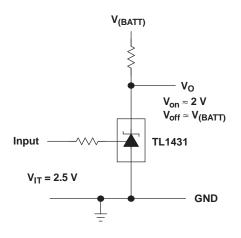
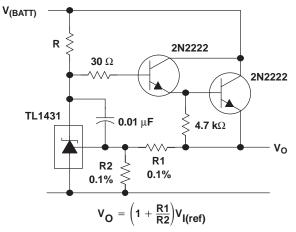


Figure 17. Single-Supply Comparator With Temperature-Compensated Threshold

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NOTE A: R should provide cathode current ≥1 mA to the TL1431 at minimum V_(BATT).

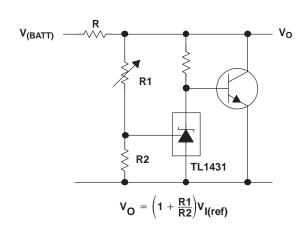


Figure 18. Precision High-Current Series Regulator

Figure 20. Higher-Current Shunt Regulator

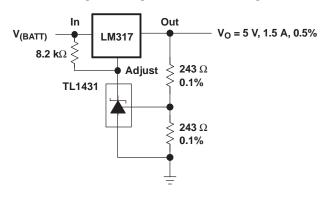


Figure 22. Precision 5-V, 1.5-A, 0.5% Regulator

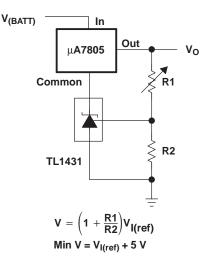
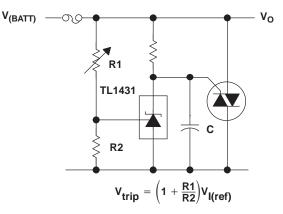


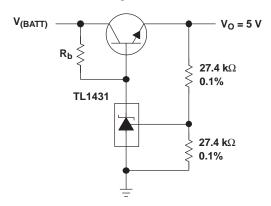


Figure 19. Output Control of a Three-Terminal Fixed Regulator



NOTE A: Refer to the stability boundary conditions in Figure 15 to determine allowable values for C.

Figure 21. Crowbar

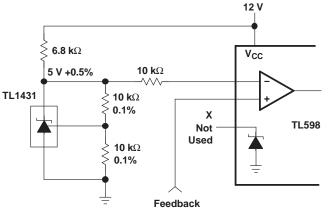


NOTE A: R_b should provide cathode current ≥ 1 mA to the TL1431.

Figure 23. Precision Regulator

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R3 V_(BATT) R1B ≶ R4 R1A 5 TL1431 TL1431 R2A \lesssim R2B $\frac{R1B}{R2B}$ V ((ref) (1 + LED on When Low Limit < V(BATT) < High Limit (1 +

NOTE A: Select R3 and R4 to provide the desired LED intensity and cathode current \geq 1 mA to the TL1431.

Figure 25. Voltage Monitor

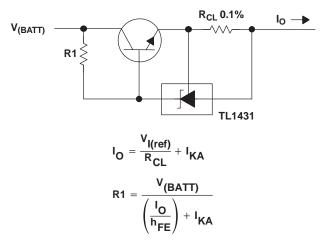


Figure 27. Precision Current Limiter

680 Ω

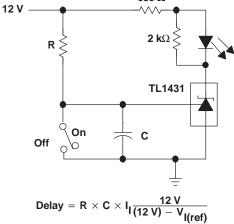


Figure 26. Delay Timer

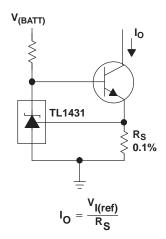
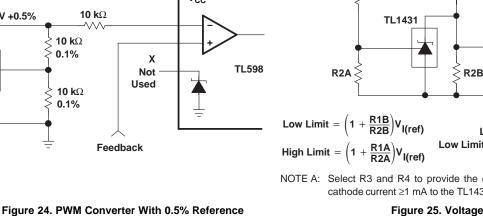


Figure 28. Precision Constant-Current Sink



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL1431MDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL1431QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04756-01XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04756-02XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AA.



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